

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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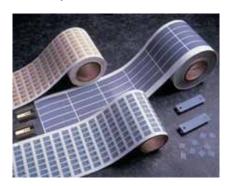




The Medium Performance Kapton®-Based Insulator

Features and Benefits

- Thermal impedance:
 0.49°C-in²/W (@50 psi)
- Physically strong dielectric barrier against cut-through
- · Medium performance film



Sil-Pad K-6 is a medium performance, filmbased thermally conductive insulator. The film is coated with a silicone elastomer to deliver high performance and provide a continuous, physically strong dielectric barrier against "cut-through" and resultant assembly failures.

TYPICAL PROPERTIES OF SIL-PAD K-6						
PRO PERT Y	IMPERIAL VALUE		METRIC VALUE		TEST METHOD	
Color	Bluegreen		Bluegreen		Visual	
Reinforcement Carrier	Kapton		Kapton		_	
Thickness (inch) / (mm)	0.006		0.152		ASTM D374	
Hardness (Shore A)	90		90		ASTM D2240	
Breaking Strength (lbs/inch) / (kN/m)	30		5		ASTM D1458	
Elongation (%)	40		40		ASTM D412	
Tensile Strength (psi) / (MPa)	5000		34		ASTM D412	
Continuous Use Temp (°F) / (°C)	-76 to 356		-60 to 180		_	
ELECTRICAL						
Dielectric Breakdown Voltage (Vac)	6000		6000		ASTM D149	
Dielectric Constant (1000 Hz)	4.0		4.0		ASTM D150	
Volume Resistivity (O hm-meter)	10 ¹²		10 ¹²		ASTM D257	
Flame Rating	VTM-O		VTM-O		U.L.94	
THERMAL						
Thermal Conductivity (W /m-K)	1.1		1.1		ASTM D5470	
THERMAL PERFORMANCE vs PRESSURE						
Pressure (psi)		10	25	50	100	200
TO -220 Thermal Performance (°C/W)		3.24	3.03	2.76	2.45	2.24
Thermal Impedance (°C-in²/W) (1)		0.82	0.62	0.49	0.41	0.36

¹⁾ The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness flatness and pressure applied.

Typical Applications Include:

· Power supplies

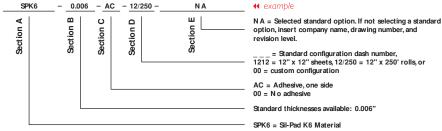
- · Motor controls
- Power semiconductors

Configurations Available:

- · Sheet form, die-cut parts and roll form
- · W ith or without pressure sensitive adhesive

Building a Part Number

Standard Options



Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad®: U.S. Patents 4,574,879; 4,602,125; 4,602,678; 4,685,987; 4,842,911 and others

Kapton® is a registered trademark of DuPont.